



# BCW120N160W1

## N-Channel Silicon Carbide Power MOSFET

1200 V, 22 A, 160 mΩ

### Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness
- Halogen Free, RoHS Compliant

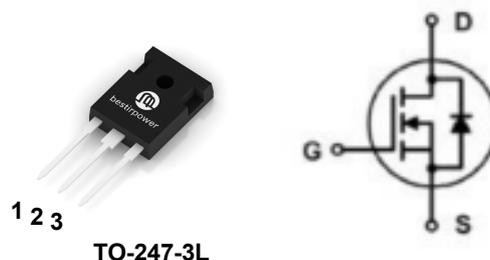
$BV_{DSS, T_C=25^\circ C}$	$I_D, T_C=25^\circ C$	$R_{DS(on), typ}$	$Q_{g, typ}$
1200 V	22 A	160 mΩ	40 nC

### Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

### Applications

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- Battery Chargers
- Motor Drives
- Pulsed Power applications



### Absolute Maximum Ratings ( $T_J = 25^\circ C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Value	Unit
$V_{DSmax}$	Drain - Source Voltage	$V_{GS}=0V, I_D=100\mu A$	1200	V
$V_{GSmax}$	Gate - Source Voltage	Absolute maximum values	-8 / +22	V
$V_{GSop}$	Gate - Source Voltage	Recommended operational values	-5 / +18	V
$I_D$	Continuous Drain Current	$V_{GS}=18V, T_C=25^\circ C$	22	A
		$V_{GS}=18V, T_C=100^\circ C$	16	
$I_{DM}$	Pulse Drain Current	Pulse width limited by $T_{jmax}$	58	A
$T_J, T_{STG}$	Operating Junction and Storage Temperature		-55 to 175	$^\circ C$

### Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.19	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	27.47	
$T_{sold}$	Soldering temperature, wave soldering only allowed at leads	260	$^\circ C$

### Electrical Characteristics (T<sub>J</sub> = 25°C, Note1)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 100 μA	1200	-	-	V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 5.0 mA, T <sub>C</sub> = 25°C	2.0	3.5	4.0	V
		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 5.0 mA, T <sub>C</sub> = 175°C	-	2.7	-	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 1200 V, V <sub>GS</sub> = 0 V	-	10	100	μA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = 18 V, V <sub>DS</sub> = 0 V	-	10	200	nA
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 18 V, I <sub>D</sub> = 10 A, T <sub>C</sub> = 25°C	-	125	180	mΩ
		V <sub>GS</sub> = 15 V, I <sub>D</sub> = 10 A, T <sub>C</sub> = 25°C	-	160	190	
		V <sub>GS</sub> = 18 V, I <sub>D</sub> = 10 A, T <sub>C</sub> = 175°C	-	220	-	
g <sub>fs</sub>	Transconductance	V <sub>GS</sub> = 18 V, I <sub>D</sub> = 10 A, T <sub>J</sub> = 25°C	-	7.0	-	S
		V <sub>GS</sub> = 18 V, I <sub>D</sub> = 10 A, T <sub>J</sub> = 175°C	-	6.0	-	
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 800 V, f = 1MHz, V <sub>AC</sub> = 25 mV	-	550	-	pF
C <sub>oss</sub>	Output Capacitance		-	28	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	8	-	
E <sub>ON</sub>	Turn-On Switching Energy	V <sub>DS</sub> = 800V, V <sub>GS</sub> = -5/18V, I <sub>D</sub> = 10A, R <sub>G(ext)</sub> = 0Ω, L = 256μH	-	200	-	μJ
E <sub>OFF</sub>	Turn-Off Switching Energy		-	50	-	
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DS</sub> = 800V, V <sub>GS</sub> = -5/18V, I <sub>D</sub> = 100A, R <sub>G(ext)</sub> = 0Ω, Timing relative to V <sub>DS</sub>	-	20	-	ns
t <sub>r</sub>	Rise Time		-	45	-	
t <sub>d(off)</sub>	Turn-Off Delay Time		-	20	-	
t <sub>f</sub>	Fall Time		-	15	-	
R <sub>G(int)</sub>	Internal Gate Resistance	f = 1 MHz, V <sub>AC</sub> = 25mV open drain	-	10.0	-	Ω
Q <sub>gs</sub>	Gate to Source Charge	V <sub>DD</sub> = 800V, V <sub>GS</sub> = -5/18V, I <sub>D</sub> = 10A	-	11	-	nC
Q <sub>gd</sub>	Gate to Drain Charge		-	8	-	
Q <sub>g</sub>	Total Gate Charge		-	40	-	

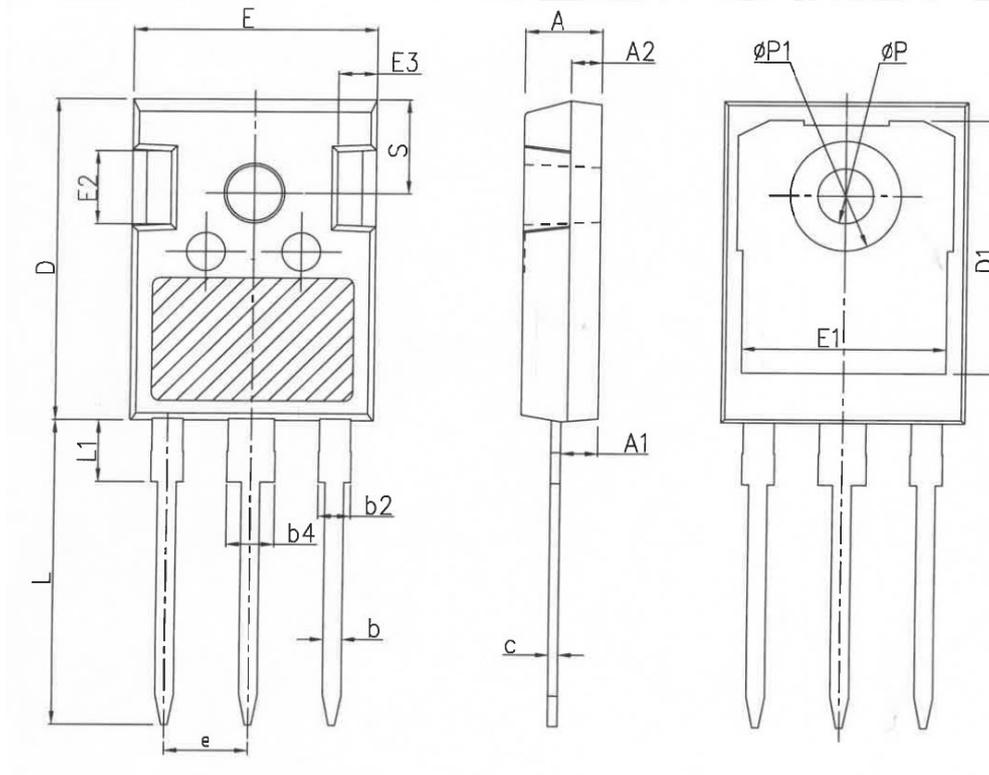
### Reverse Diode Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 5 A, T <sub>J</sub> = 25°C	-	3.5	-	V
		V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 5 A, T <sub>J</sub> = 175°C	-	3.2	-	
I <sub>S</sub>	Continuous Diode Forward Current	T <sub>C</sub> = 25°C	-	-	30	A
t <sub>rr</sub>	Reverse Recovery time	V <sub>GS</sub> = -5V, I <sub>SD</sub> = 10 A, V <sub>R</sub> = 800V, dif / dt = 1200A/μs;	-	10	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	40	-	nC
I <sub>rrm</sub>	Peak Reverse Recovery Current		-	3	-	A

※. Note 1 : Limited by maximum junction temperature.

Package  
Outlines

# TO247-3



COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.62	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		

\* Dimensions in millimeters

### Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
BCW120N160W1	BCW120N160W1	TO247-3L	Tube	30 units

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